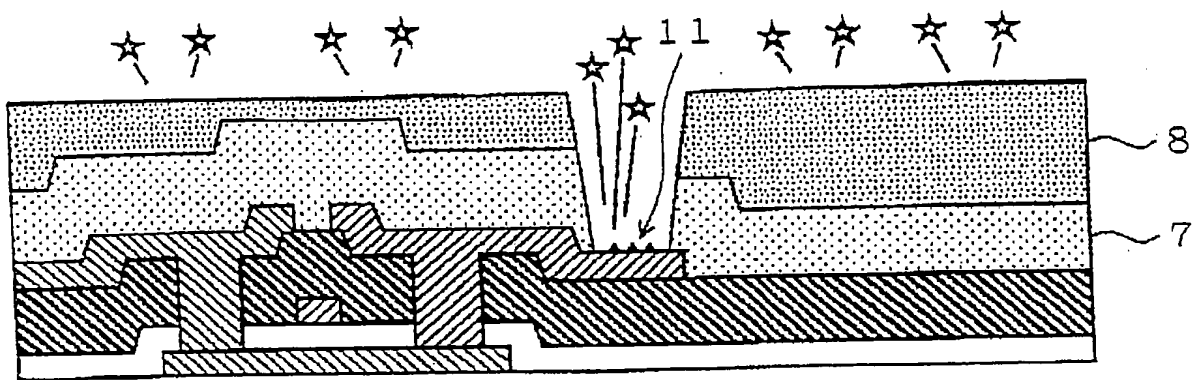


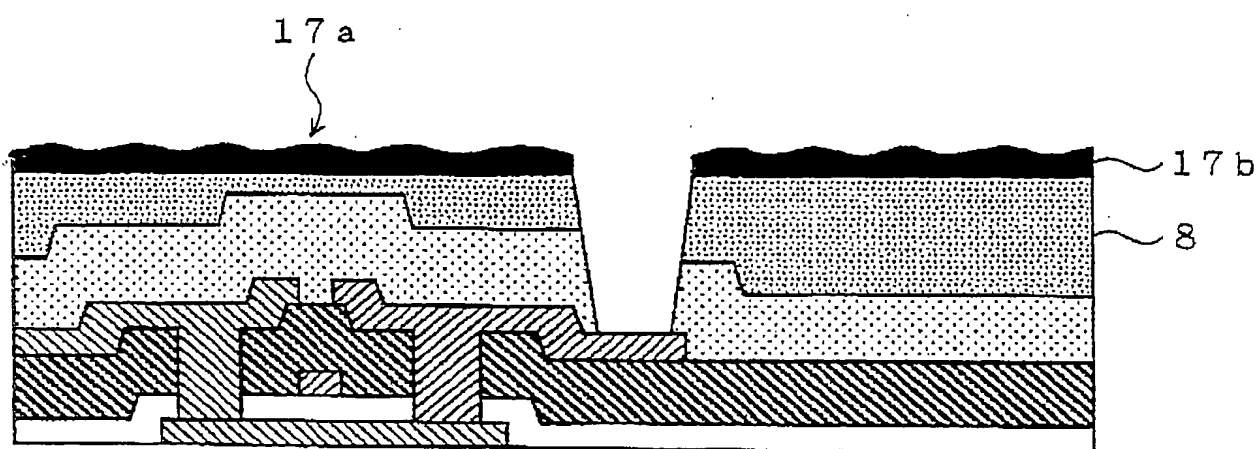
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FIG. 1A prior art

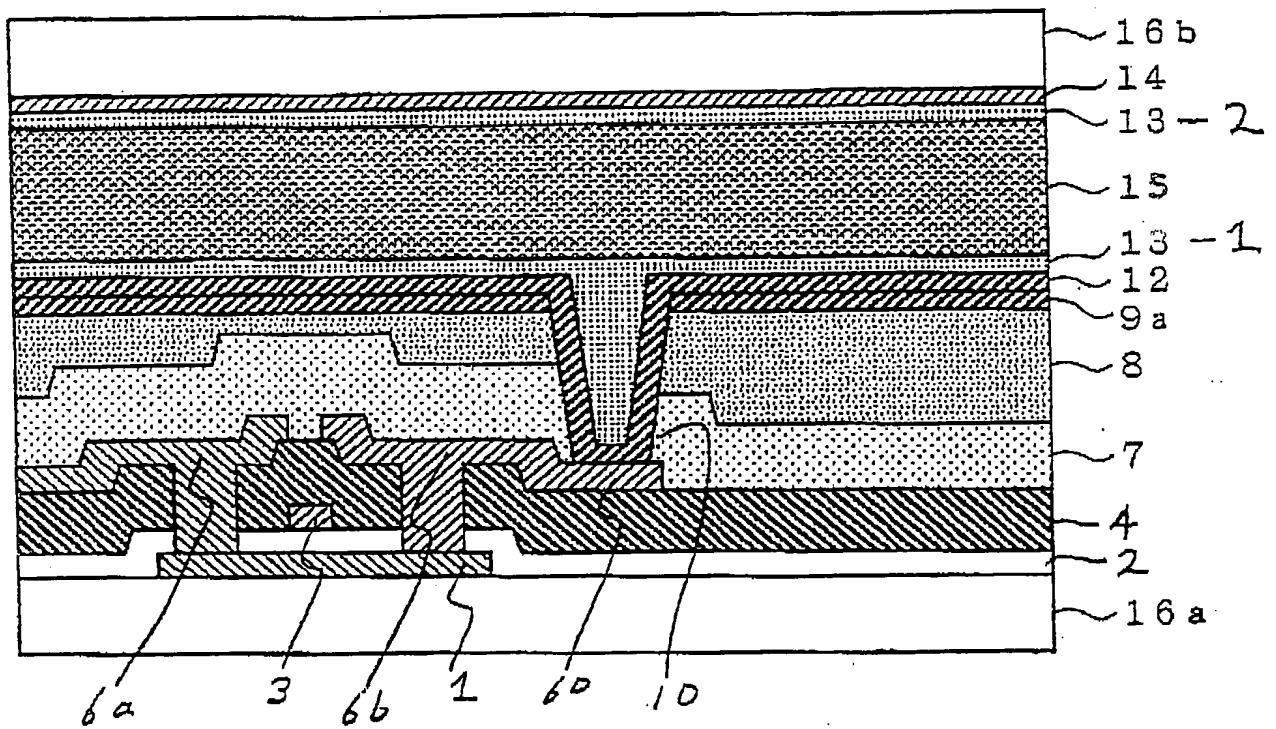


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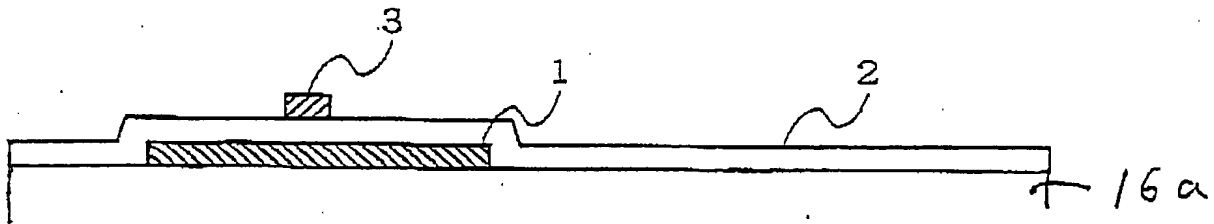
FIG. 1B prior art



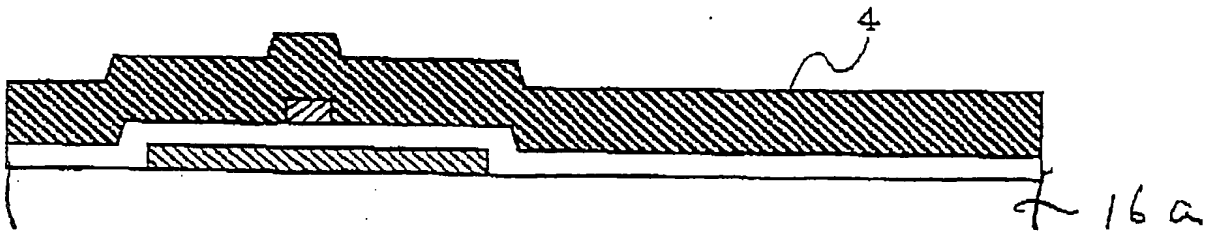
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FIG. 2



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FIG. 3A

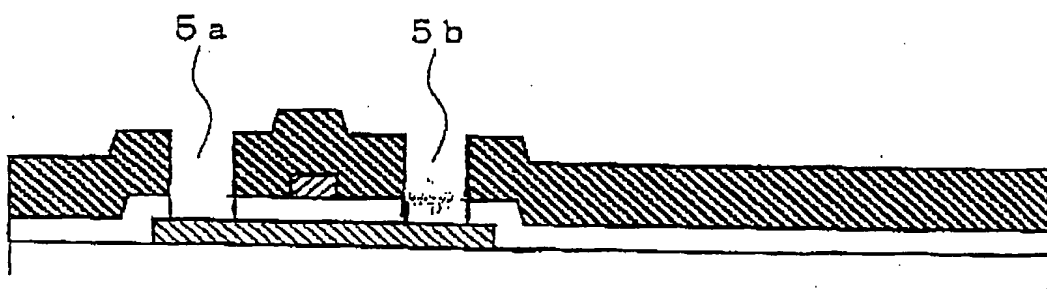


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FIG. 3B



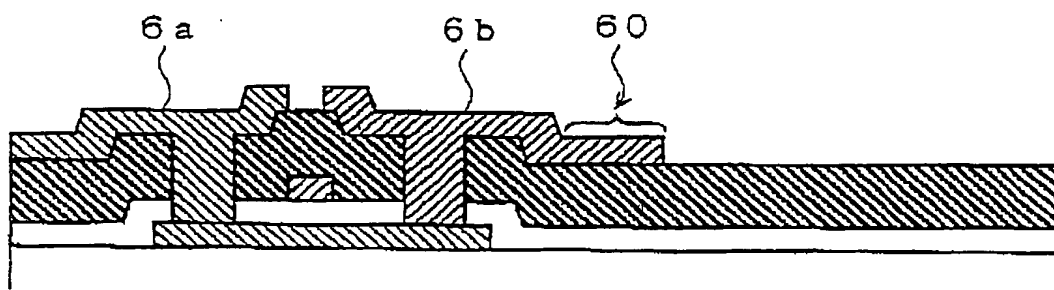
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FIG. 3C



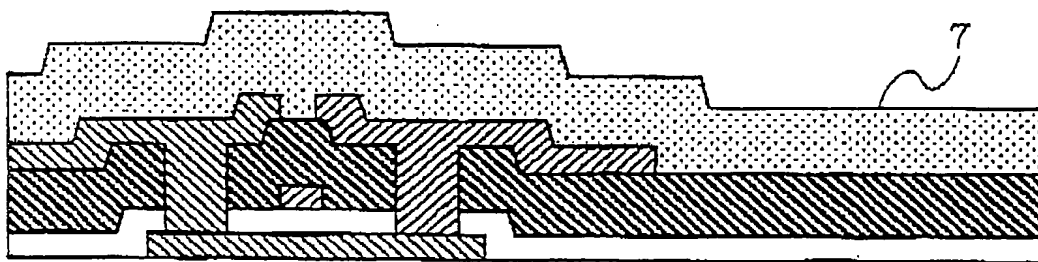
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FIG. 3D



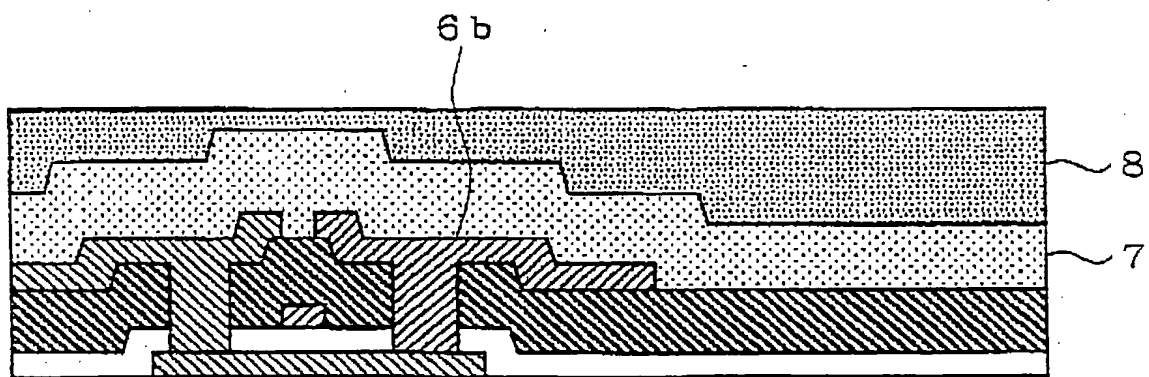
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FIG. 3E



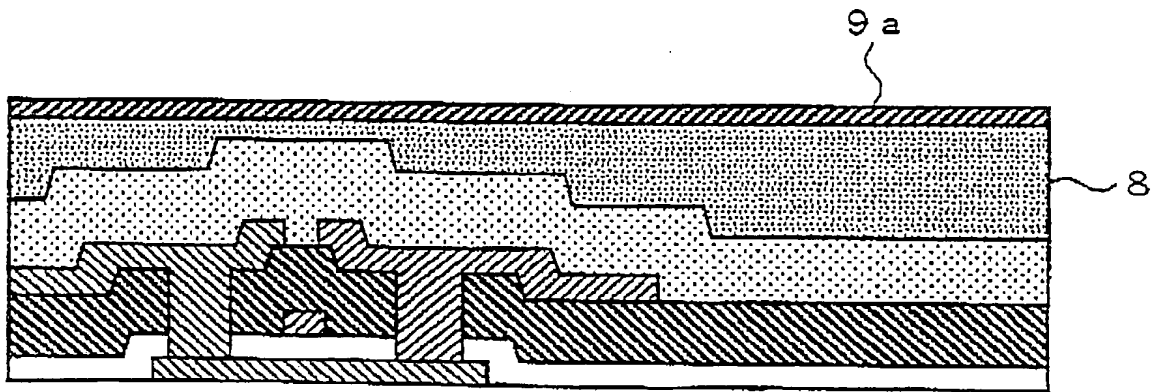
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FIG. 3F



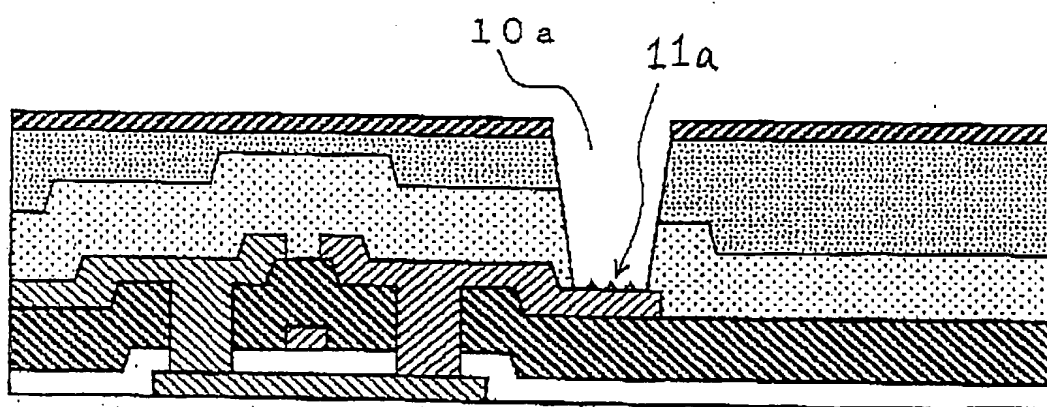
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FIG. 3G



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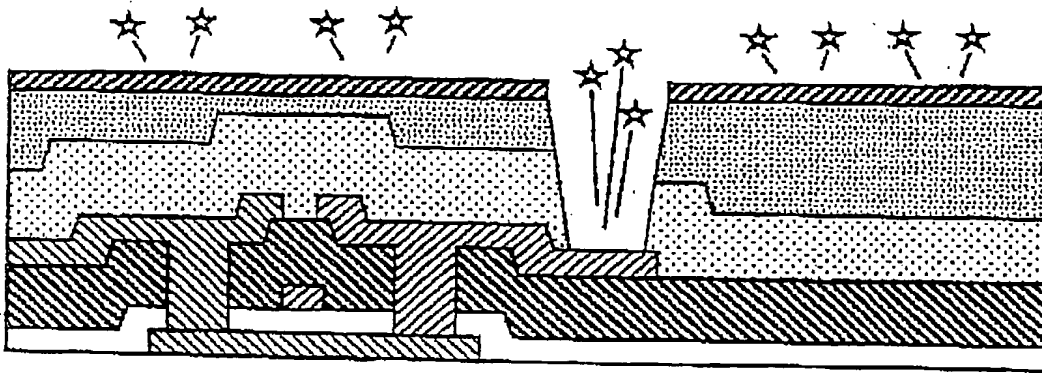
FIG. 3H



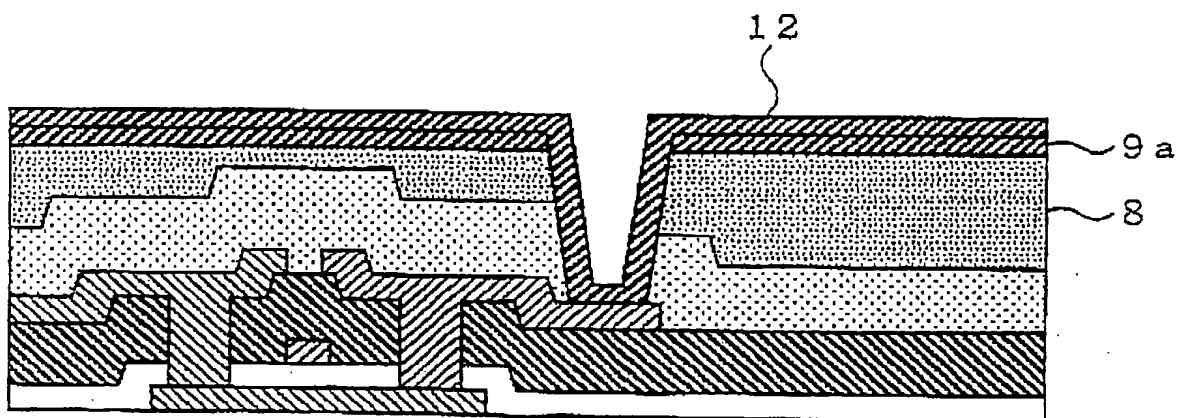
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FIG. 3I

Sputter Cleaning (Sputter Etching)

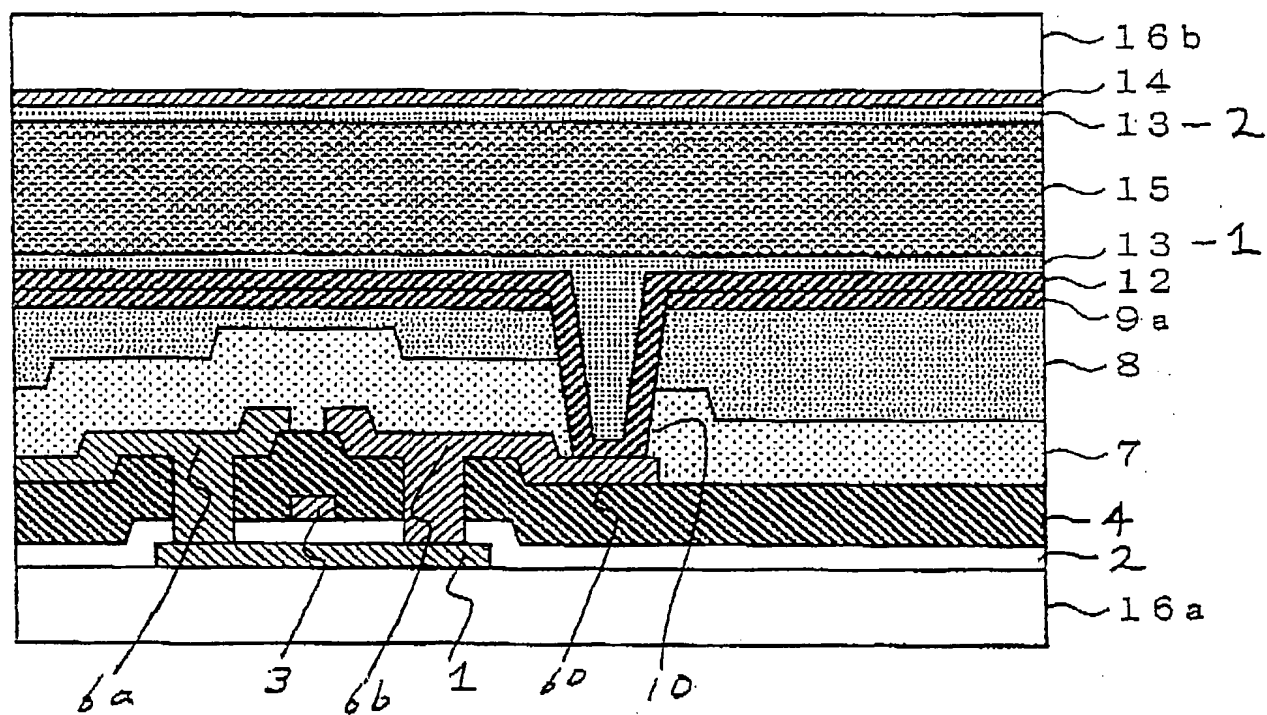


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FIG. 3J



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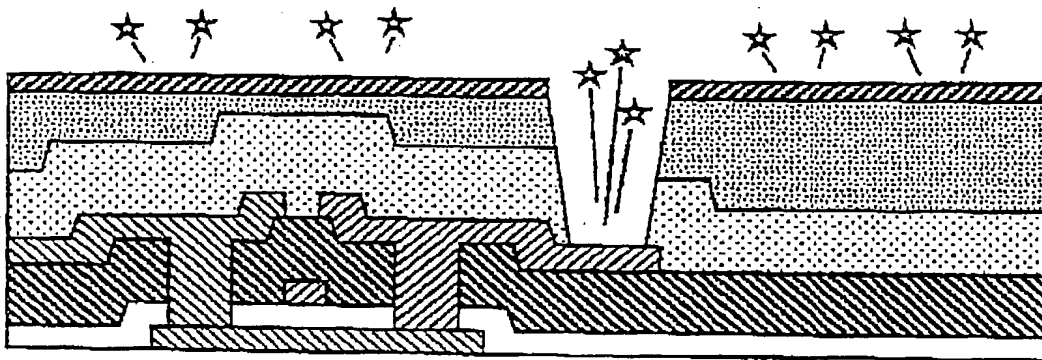
FIG. 3K



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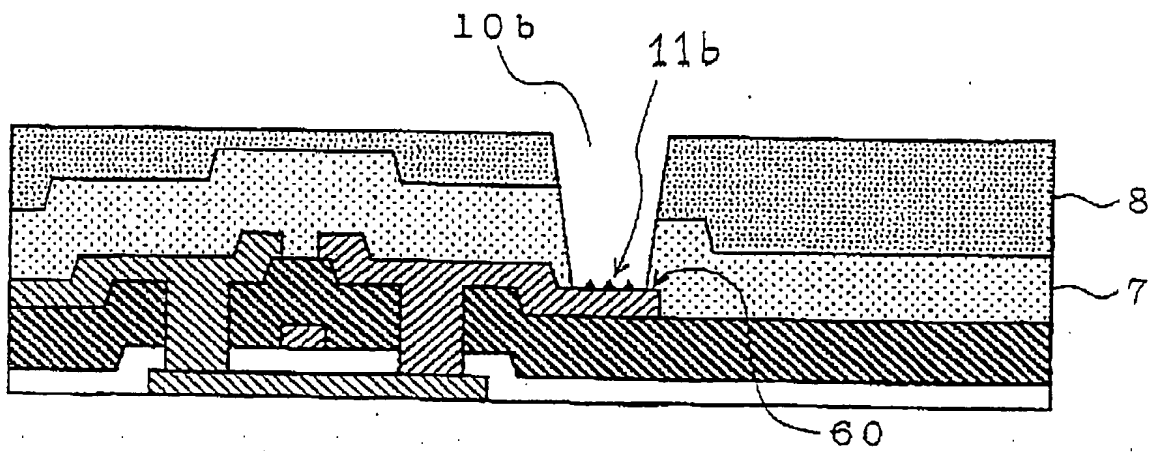
FIG. 4

Plasma Ashing



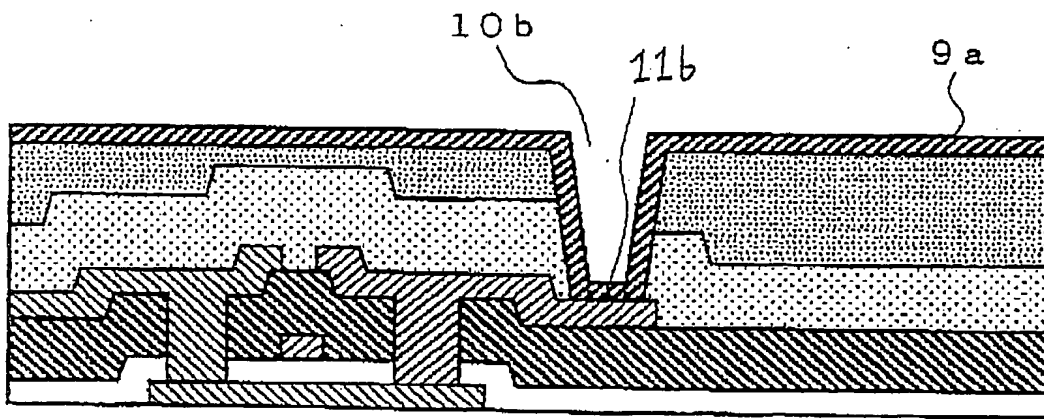
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FIG. 5A



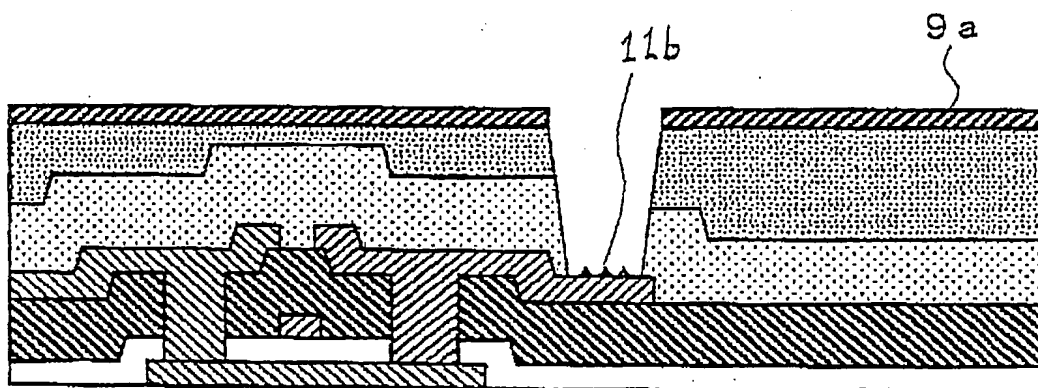
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FIG. 5B



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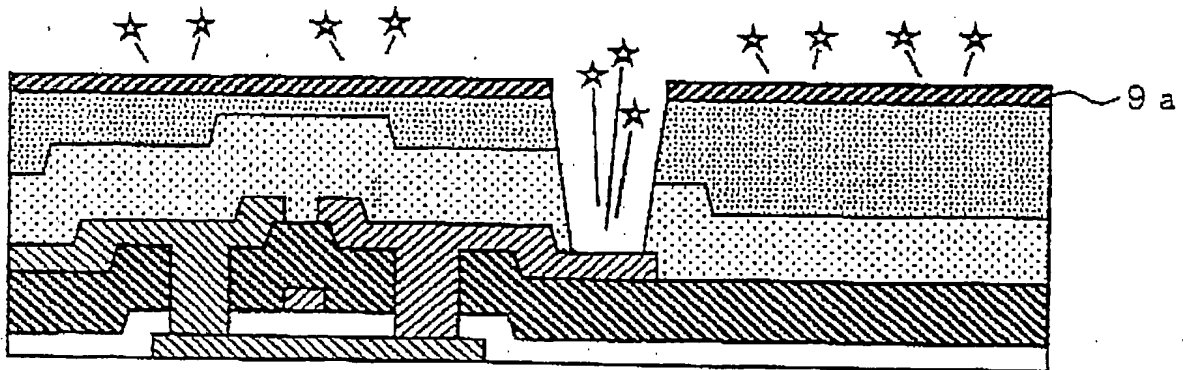
FIG. 5C



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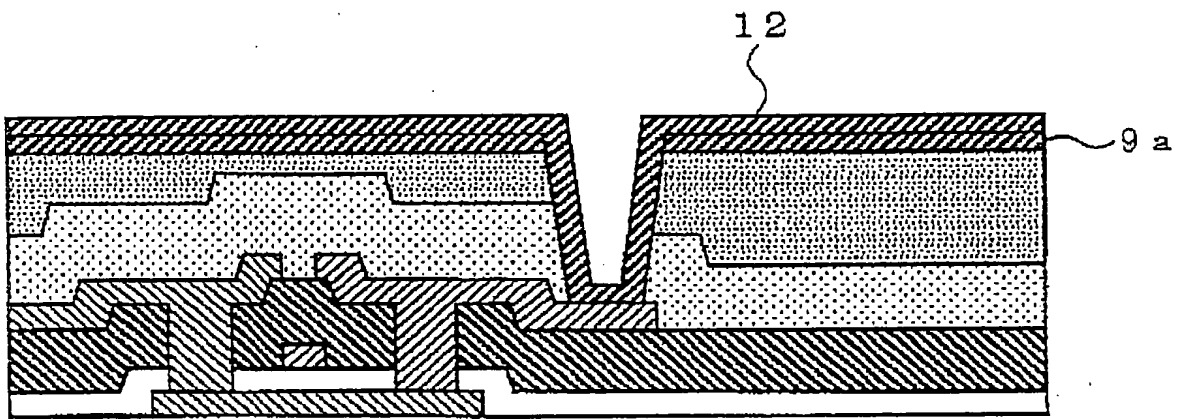
FIG. 5D

Sputter Cleaning (Sputter Etching)



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FIG. 5E



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FIG. 6

Plasma Ashing

